

Description

The AP3400MI uses advanced trench technology to provide excellent $R_{DS(ON)}$, low gate charge and operation with gate voltages as low as 2.5V. This device is suitable for use as a

Battery protection or in other Switching application.

General Features

 $V_{DS} = 30V I_{D} = 5.8A$

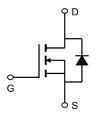
 $R_{DS(ON)}$ < 25m Ω @ V_{GS} =10V

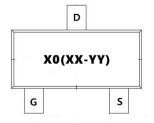
Application

Battery protection

Load switch

Uninterruptible power supply







Package Marking and Ordering Information

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Product ID	Pack	Marking	Qty(PCS)	
AP3400MI	SOT-23-3L	X0(XX-YY).	3000	

Absolute Maximum Ratings (T_C=25°Cunless otherwise noted)

Symbol	Parameter	Rating	Units	
V _D S	Drain-Source Voltage	30	V	
Vgs	Gate-Source Voltage	±12	V	
I _D @T _A =25°C	Continuous Drain Current	5.8	А	
I _D @T _A =70°C	Continuous Drain Current	4.9	А	
Ідм	Pulsed Drain Current ²	20	А	
P _D @T _A =25°C	Total Power Dissipation ³	1	W	
Тѕтс	Storage Temperature Range	-55 to 150	°C	
TJ	Operating Junction Temperature Range	-55 to 150	°C	
Reja	R _{8JA} Thermal Resistance Junction-ambient ¹ 125		°C/W	
R _θ JA	Thermal Resistance Junction-Ambient ¹ (t ≤10s)) 85 °C/W		





Electrical Characteristics (T_J=25 °C, unless otherwise noted)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit	
BVDSS	Drain-Source Breakdown Voltage	V _{GS} =0V , I _D =250uA	30			V	
△BV _{DSS} /△T _J	BVDSS Temperature Coefficient	Reference to 25°C , I _D =1mA		0.029		V/°C	
		V _{GS} =10V , I _D =5A		21	25		
RDS(ON)	Static Drain-Source On-Resistance ²	V _{GS} =4.5V , I _D =3A		23	31	mΩ	
		V _{GS} =2.5V , I _D =1A		30	49		
V _{GS(th)}	Gate Threshold Voltage	\/ -\/ -250\	0.5		1.2	V	
$\triangle V_{\text{GS(th)}}$	V _{GS(th)} Temperature Coefficient	$V_{GS}=V_{DS}$, $I_D=250uA$		-2.82		mV/°C	
	D : 0	V _{DS} =24V , V _{GS} =0V , T _J =25°C			1	•	
Ipss	Drain-Source Leakage Current	V _{DS} =24V , V _{GS} =0V , T _J =55°C			5	uA	
Igss	Gate-Source Leakage Current	V _{GS} =±12V , V _{DS} =0V			±100	nA	
gfs	Forward Transconductance	V _{DS} =5V , I _D =5A		25		S	
Rg	Gate Resistance	V _{DS} =0V , V _{GS} =0V , f=1MHz		1.5		Ω	
Qg	Total Gate Charge (4.5V)			11.5			
Qgs	Gate-Source Charge	V _{DS} =15V , V _{GS} =4.5V , I _D =5.8A		1.6		nC	
Qgd	Gate-Drain Charge			2.9			
Td(on)	Turn-On Delay Time			5			
Tr	Rise Time	V_{DD} =15V , V_{GS} =10V , R_{G} =3 Ω		47.		ne	
Td(off)	Turn-Off Delay Time	I _D =5A		26		ns	
Tf	Fall Time			8			
Ciss	Input Capacitance			530			
Coss	Output Capacitance	V _{DS} =15V , V _{GS} =0V , f=1MHz		130		pF	
Crss	Reverse Transfer Capacitance			36			
ls	Continuous Source Current ^{1,4}	V _G =V _D =0V , Force Current			5.8	Α	
Vsd	Diode Forward Voltage ²	V _{GS} =0V , I _S =1A , T _J =25°C			1.2	V	

Note:

- 1. The data tested by surface mounted on a 1 inch² FR-4 board with 2OZ copper.
- 2. The data tested by pulsed , pulse width $\leq 300 \text{us}$, duty cycle $\leq 2\%$
- $3 {\,{}^{^{\circ}}}$ The power dissipation is limited by $150 {\,{}^{\circ}\!{}^{^{\circ}}}$ junction temperature
- 4 . The data is theoretically the same as I_D and I_{DM} , in real applications, should be limited by total power dissipation.



Typical Characteristics

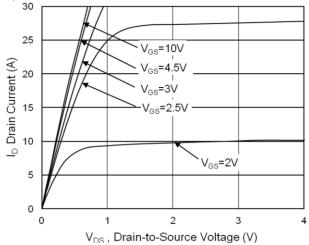


Fig.1 Typical Output Characteristics

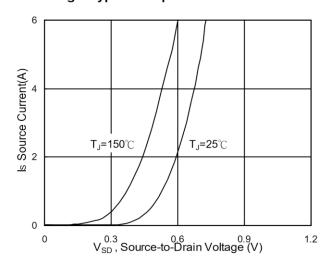


Fig.3 Forward Characteristics Of Reverse

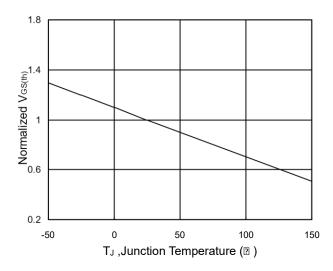


Fig.5 Normalized V_{GS(th)} vs. T_J

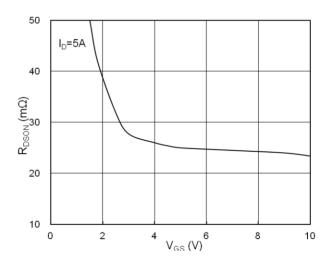


Fig.2 On-Resistance vs. Gate-Source

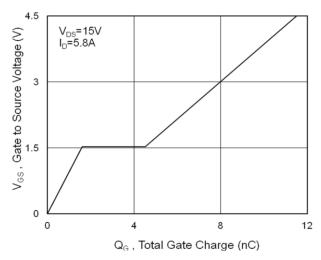


Fig.4 Gate-Charge Characteristics

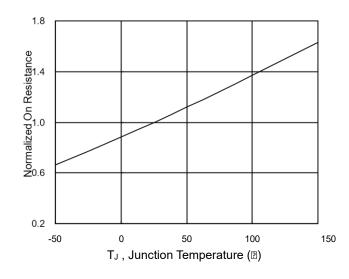
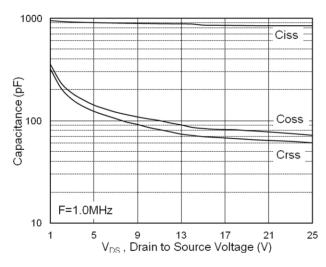


Fig.6 Normalized R_{DSON} vs. T_J







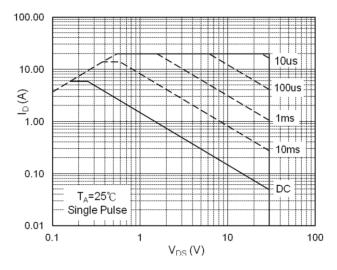


Fig.7 Capacitance

Fig.8 Safe Operating Area

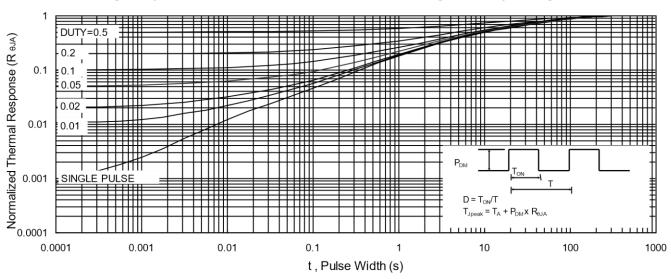


Fig.9 Normalized Maximum Transient Thermal Impedance

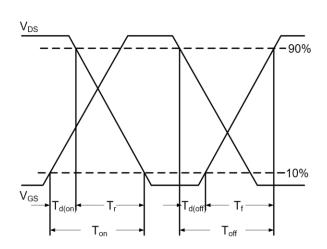


Fig.10 Switching Time Waveform

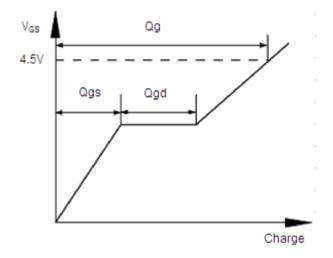
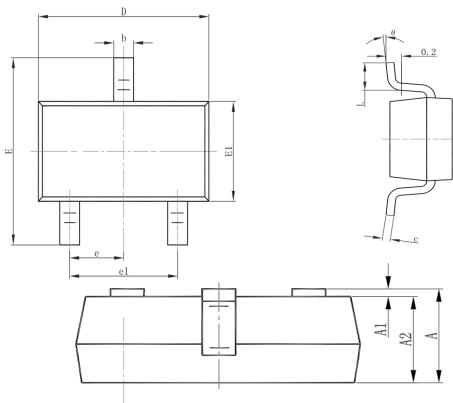


Fig.11 Gate Charge Waveform





Package Mechanical Data-SOT23-3



Country of	Dimensions I	ons In Millimeters Dim		ensions In Inches	
Symbol	Min.	Max.	Min.	Max.	
Α	1.050	1.250	0.041	0.049	
A1	0.000	0.100	0.000	0.004	
A2	1.050	1.150	0.041	0.045	
b	0.300	0.500	0.012	0.020	
С	0.100	0.200	0.004	0.008	
D	2.820	3.020	0.111	0.119	
E1	1.500	1.700	0.059	0.067	
E	2.650	2.950	0.104	0.116	
е	0.950	(BSC)	0.03	7(BSC)	
e1	1.800	2.000	0.071	0.079	
L	0.300	0.600	0.012	0.024	
θ	0°	8°	0°	8°	



30V N-Channel Enhancement Mode MOSFET Attention

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AP3400MI

30V N-Channel Enhancement Mode MOSFET

Edition	Date	Change
Rve3.8	2017/5/1	Initial release
Rve3.9	2020/5/20	Reduce RDS(on)

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